




SPECIFICATION SHEET

SPECIFICATION SHEET NO.	N0310-SMAFUS1MF0S10A
DATE	Mar. 10, 2021
REVISION	A0
DESCRIPTION	<p>SMD High Efficiency Rectifier, 2 Pads, SMAF series, US1MF Type</p> <p>Reverse Voltage 1000V Max. Forward Current 1.0A Max.</p> <p>Operating Temp. Range -50°C ~+150°C</p> <p>Package in Tape/Reel, 3000pcs/Reel</p> <p>RoHS/RoHS III compliant</p>
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	MDD US1MF
PART CODE	SMAFUS1MF0S10A

VENDOR APPROVE			
Issued/Checked/Approved			
DATE: March 10, 2021			

CUSTOMER APPROVE	
DATE:	

SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES



MAIN FEATURE

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Low reverse leakage
- Built-in strain relief,
- High forward surge current capability
- Ultra fast switching for high efficiency
- High temperature soldering guaranteed: 250°C/ 10 seconds at terminals

APPLICATION

- For printed circuit board

RFQ

[Request For Quotation](#)

PART CODE GUIDE

SMAF	US1MF0	S	10A
1	2	3	4

- 1) **SMAF**: SMD High Efficiency Rectifier, 2 Pads, SMAF series
- 2) **US1MF0**: Type code for original part number US1MF
- 3) **S**: Package code, Tape/reel, 3000pcs/reel.
- 4) **10A**: Specification code for Reverse Voltage 1000V Max. Forward Current 1.0A Max.

MORE ITEMS AVAILABLE

SMAFUS1AF0S105	SMAFUS1BF0S110	SMAFUS1DF0S120	SMAFUS1GF0S140	SMAFUS1JF0S160
SMAFUS1KF0S180	SMAFUS1MF0S10A			
SMAFUS2A00S205	SMAFUS2B00S210	SMAFUS2D00S220	SMAFUS2G00S240	SMAFUS2J00S260
SMAFUS2K00S280	SMAFUS2M00S20A			
SMAFUS3A00S305	SMAFUS3B00S310	SMAFUS3D00S320	SMAFUS3G00S340	SMAFUS3J00S360
SMAFUS3K00S380	SMAFUS3M00S30A			

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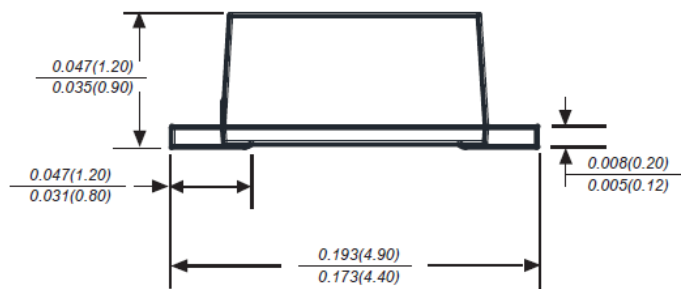
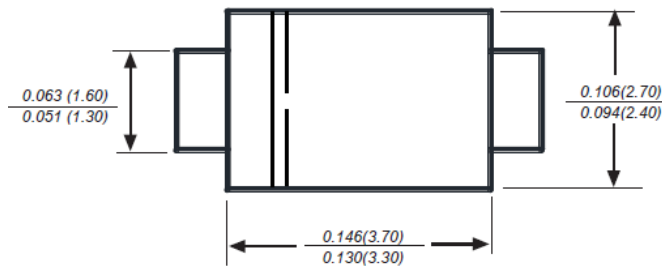
DIMENSION (Unit: Inch/mm)

Image for reference

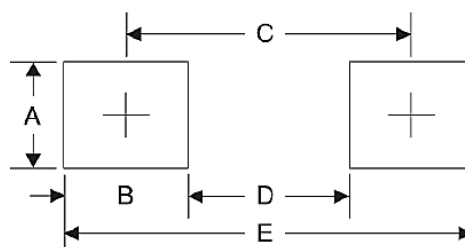


Marking: US1MF

SMAF



Recommend Pad Layout



Symbol	Unit (Inch)	Unit (mm)
A	0.071	1.80
B	0.063	1.60
C	0.150	3.80
D	0.087	2.21
E	0.213	5.40

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MECHANICAL DATA

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC SMAF molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on case	Any	0.0020 Ounce, 0.0567 grams

MAX. RATING & CHARACTERISTICS

Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
Repetitive peak reverse voltage	V _{RRM}			1000	Volts
RMS voltage	V _{RMS}			700	Volts
DC blocking voltage	V _{DC}			1000	Volts
Average forward output rectified current at TL= 55°C	I _{AV}			1.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}		30		A
Instantaneous forward voltage at 1.0A	V _F			1.70	Volts
DC reverse current at rated DC blocking voltage	I _R	TA=25°C		5	μA
		TA=125°C		50	μA
Reverse recovery time (NOTE 2)	T _{rr}			75	ns
Junction capacitance (Note 3)	C _J		15		pF
Thermal resistance (Note 4)	R _{QJA}		50		°C/W
Operating junction temperature range	T _J	-55		+150	°C
Storage temperature range	T _{STG}	-55		+150	°C

Note

1. Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
2. Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A
3. Measured at 1.0MHz and applied reverse voltage of 4.0Voltage
4. P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas.

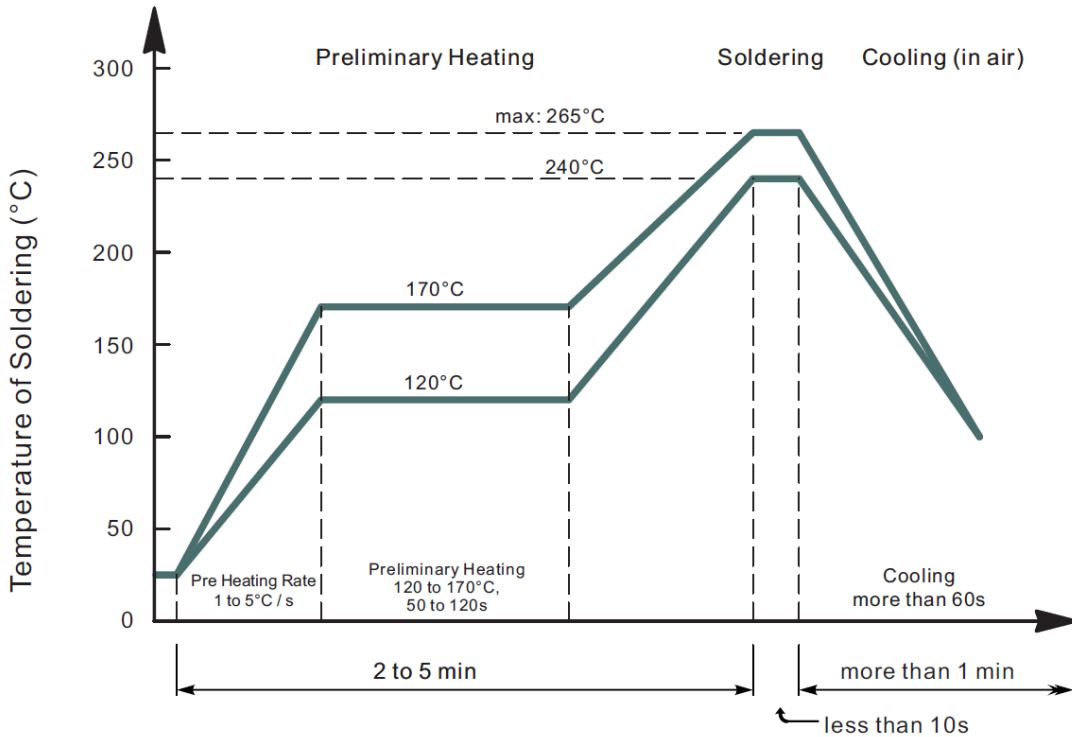
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RELIABILITY

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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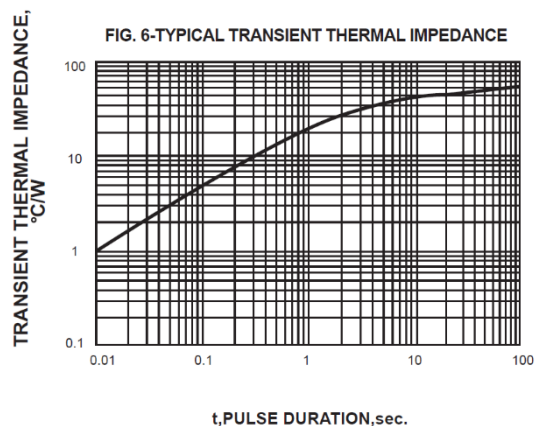
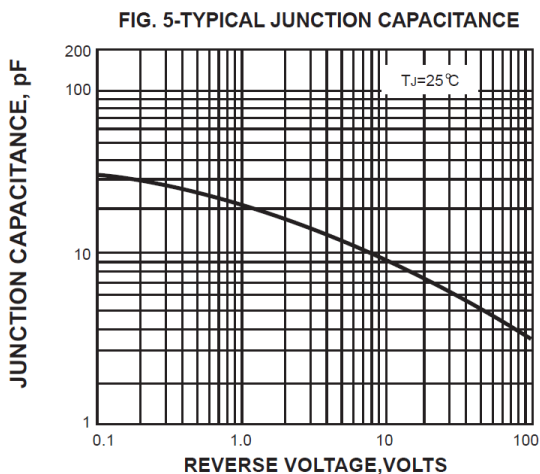
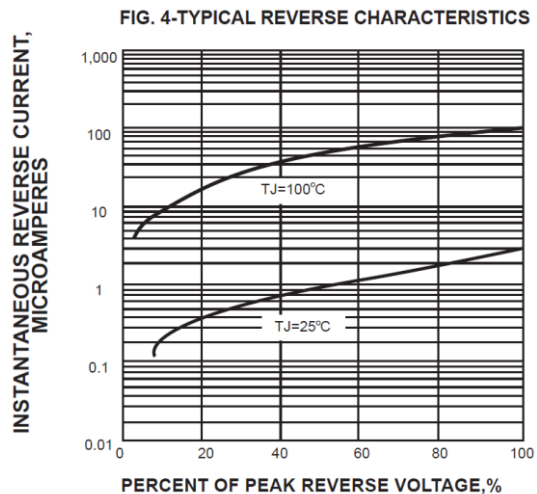
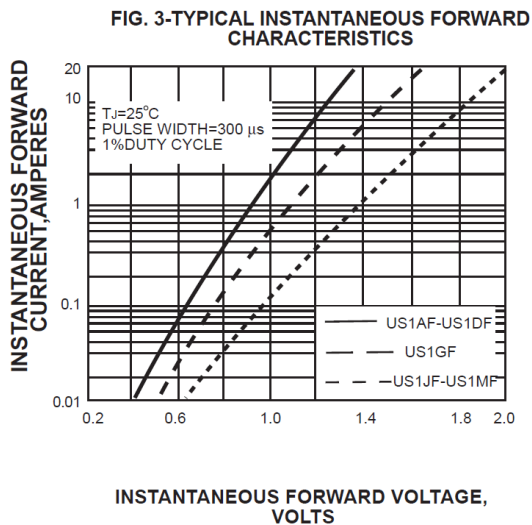
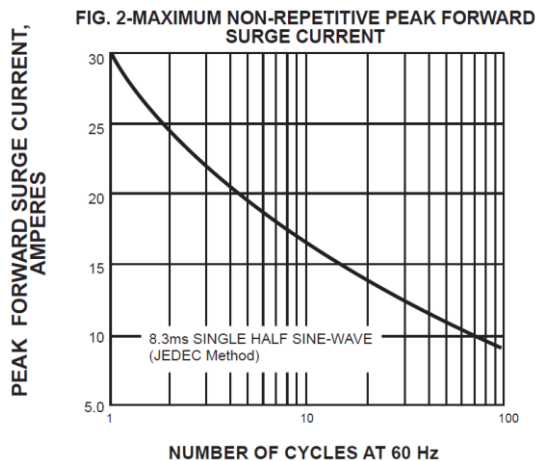
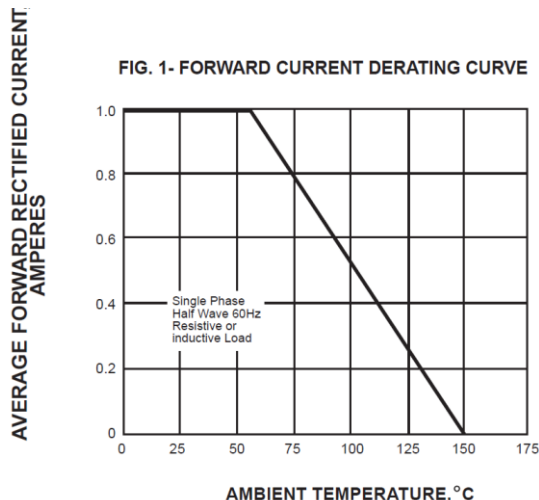
SUGGESTED REFLOW PROFILE (For Reference Only)



- Recommended peak temperature is over 245°C, If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)
- Welding shall not exceed 2 times
- Remark: lead free solder paste (96.5 sn/3.0 Ag/0.5Cu)

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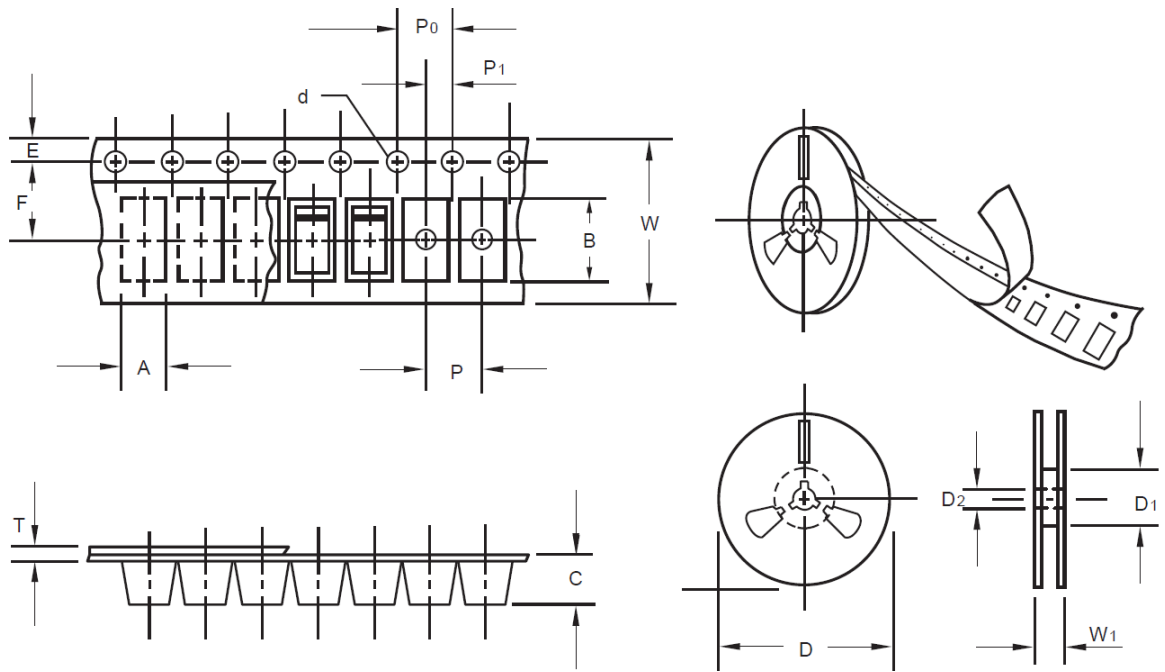
RATINGS AND CHARACTERISTIC CURVES (For Reference Only)



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TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.

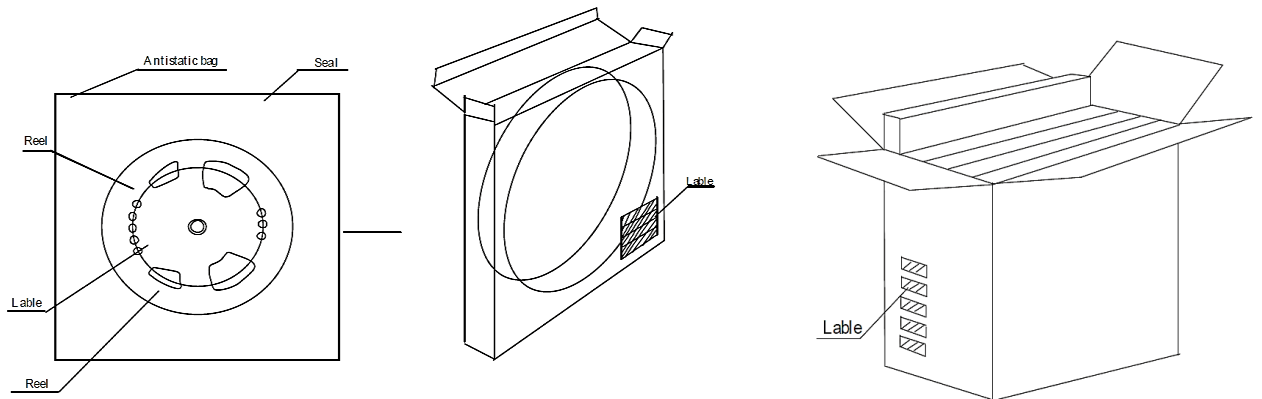


Item	Symbol	Tolerance	SMAF
Carrier width	A	0.1	2.80
Carrier Length	B	0.1	4.75
Carrier Depth	C	0.1	1.42
Sprocket hole	d	0.05	1.50
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D1	Min.	54.40
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.05
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.30
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.30

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PACKAGE

Case Code	Reel Size	MPQ (pcs)	Component Spacing (mm)	Qty. Per Box (pcs)	Inner Box L*W*H (mm)	Reel Size (mm)	Carton size L*W*H (mm)	Qty. Per Carton (pcs)	G. W (kg)
SMAF	7"	3,000		6,000	210*208*203	178	400*400*250	120,000	10.0



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